

Provisional Data  
**Avalanche Diode**  
Type W3270N#22A

**Absolute Maximum Ratings**

	VOLTAGE RATINGS	MAXIMUM LIMITS	UNITS
$V_{RRM}$	Repetitive peak reverse voltage, (note 1)	2200	V
$V_{RSM}$	Non-repetitive peak reverse voltage, (note 1)	2300	V
$P_{RSM}$	Maximum surge reverse power dissipation, (note 2)	100	kW

	OTHER RATINGS	MAXIMUM LIMITS	UNITS
$I_{F(AV)M}$	Maximum average forward current, $T_{sink}=55^{\circ}C$ , (note 3)	3239	A
$I_{F(AV)M}$	Maximum average forward current. $T_{sink}=85^{\circ}C$ , (note 3)	2670	A
$I_{F(AV)M}$	Maximum average forward current. $T_{sink}=85^{\circ}C$ , (note 4)	1630	A
$I_{F(RMS)M}$	Nominal RMS forward current, $T_{sink}=25^{\circ}C$ , (note 3)	5887	A
$I_{F(d.c.)}$	D.C. forward current, $T_{sink}=25^{\circ}C$ , (note 5)	5015	A
$I_{FSM}$	Peak non-repetitive surge $t_p=10ms$ , $V_{rm}=60\%V_{RRM}$ , (note 6)	27.6	kA
$I_{FSM2}$	Peak non-repetitive surge $t_p=10ms$ , $V_{rm}\leq 10V$ , (note 6)	30.4	kA
$I^2t$	$I^2t$ capacity for fusing $t_p=10ms$ , $V_{rm}=60\%V_{RRM}$ , (note 6)	$3.81 \times 10^6$	$A^2s$
$I^2t$	$I^2t$ capacity for fusing $t_p=10ms$ , $V_{rm}\leq 10V$ , (note 6)	$4.62 \times 10^6$	$A^2s$
$T_{j op}$	Operating temperature range	-55 to +175	$^{\circ}C$
$T_{stg}$	Storage temperature range	-55 to +200	$^{\circ}C$

Notes:-

- 1) De-rating factor of 0.13% per  $^{\circ}C$  is applicable for  $T_j$  below  $25^{\circ}C$ .
- 2) In accordance with IEC60747-2 clause 7.3.3.1 (Triangular waveform pulse method),  $t_p=3\mu s$ .
- 3) Double side cooled, single phase; 50Hz,  $180^{\circ}$  half-sinewave.
- 4) Single side cooled, single phase; 50Hz,  $180^{\circ}$  half-sinewave.
- 5) Double side cooled.
- 6) Half-sinewave,  $175^{\circ}C$   $T_j$  initial.

**Characteristics**

	PARAMETER	MIN.	TYP.	MAX.	TEST CONDITIONS (Note 1)	UNITS
V <sub>FM</sub>	Maximum peak forward voltage	-	-	1.52	I <sub>TM</sub> =6400A	V
V <sub>FM</sub>	Maximum peak forward voltage	-	-	1.84	I <sub>TM</sub> =9800A	V
V <sub>T0</sub>	Threshold voltage	-	-	0.818		V
r <sub>T</sub>	Slope resistance	-	-	0.108		mΩ
I <sub>R<sub>RRM</sub></sub>	Peak reverse current	-	-	50	Rated V <sub>RRM</sub>	mA
I <sub>R<sub>RRM</sub></sub>	Peak reverse current	-	-	50	Rated V <sub>RRM</sub> , T <sub>j</sub> =25°C	mA
Q <sub>rr</sub>	Recovered charge	-	3000	3450		μC
Q <sub>ra</sub>	Recovered charge, 50% Chord	-	2300	-	I <sub>TM</sub> =1000A, t <sub>p</sub> =1000μs, di/dt=10A/μs, V <sub>r</sub> =50V	μC
I <sub>rr</sub>	Reverse recovery current	-	160	-		A
t <sub>rr</sub>	Reverse recovery time	-	29	-		μs
R <sub>thJK</sub>	Thermal resistance, junction to heatsink	-	-	0.022	Double side cooled	K/W
		-	-	0.044	Single side cooled	K/W
F	Mounting force	19	-	26	Note 2	kN
W <sub>t</sub>	Weight	-	510	-		g

Notes:-

- 1) Unless otherwise indicated T<sub>j</sub>=175°C.
- 2) For other clamp forces, please consult factory.

**Notes on rupture rated packages.**

This product is available with a non-rupture rated package.

For additional details on these products, please consult factory.

**Notes on Ratings and Characteristics**

1.0 Voltage Grade Table

Voltage Grade	$V_{RRM}$ V	$V_{RSM}$ V	$V_R$ DC V
22	2200	2300	1350

2.0 Extension of Voltage Grades

This report is applicable to other voltage grades when supply has been agreed by Sales/Production.

3.0 De-rating Factor

A blocking voltage de-rating factor of 0.13%/°C is applicable to this device for T<sub>j</sub> below 25°C.

4.0 Snubber Components

When selecting snubber components, care must be taken not to use excessively large values of snubber capacitor or excessively small values of snubber resistor. Such excessive component values may lead to device damage due to the large resultant values of snubber discharge current. If required, please consult the factory for assistance.

5.0 Computer Modelling Parameters

5.1 Device Dissipation Calculations

$$I_{AV} = \frac{-V_{T0} + \sqrt{V_{T0}^2 + 4 \cdot ff^2 \cdot r_T \cdot W_{AV}}}{2 \cdot ff^2 \cdot r_T} \quad \text{and:} \quad W_{AV} = \frac{\Delta T}{R_{th}}$$

$$\Delta T = T_{j\max} - T_K$$

Where V<sub>T0</sub>=0.818V, r<sub>T</sub>=0.108mΩ,

R<sub>th</sub> = Supplementary thermal impedance, see table below and

ff = Form factor, see table below.

Supplementary Thermal Impedance				
Conduction Angle	6 phase (60°)	3 phase (120°)	½ wave (180°)	d.c.
Square wave Double Side Cooled	0.0285	0.0255	0.0240	0.0220
Square wave Single Side Cooled	0.0513	0.0484	0.0469	0.0440
Sine wave Double Side Cooled	0.0257	0.0233	0.022	
Sine wave Single Side Cooled	0.0482	0.0463	0.044	

Form Factors				
Conduction Angle	6 phase (60°)	3 phase (120°)	½ wave (180°)	d.c.
Square wave	2.449	1.732	1.414	1
Sine wave	2.778	1.879	1.57	

## 5.2 Calculating $V_F$ using ABCD Coefficients

The on-state characteristic  $I_F$  vs.  $V_F$ , on page 6 is represented in two ways;

- (i) the well established  $V_{T0}$  and  $r_f$  tangent used for rating purposes and
- (ii) a set of constants A, B, C, D, forming the coefficients of the representative equation for  $V_F$  in terms of  $I_F$  given below:

$$V_F = A + B \cdot \ln(I_F) + C \cdot I_F + D \cdot \sqrt{I_F}$$

The constants, derived by curve fitting software, are given below for both hot and cold characteristics. The resulting values for  $V_F$  agree with the true device characteristic over a current range, which is limited to that plotted.

	25°C Coefficients	175°C Coefficients
A	1.629038	0.7019069
B	-0.1913977	-0.02419013
C	-6.288E-05	4.58848E-05
D	0.02409212	0.009205413

5.3 D.C. Thermal Impedance Calculation

$$r_t = \sum_{p=1}^{p=n} r_p \cdot \left( 1 - e^{-\frac{t}{\tau_p}} \right)$$

Where  $p = 1$  to  $n$ ,  $n$  is the number of terms in the series and:

- $t$  = Duration of heating pulse in seconds.
- $r_t$  = Thermal resistance at time  $t$ .
- $r_p$  = Amplitude of  $p_{th}$  term.
- $\tau_p$  = Time Constant of  $r_{th}$  term.

The coefficients for this device are shown in the tables below:

D.C. Single Side Cooled					
Term	1	2	3	4	5
$r_p$	0.0291698	$4.295845 \times 10^{-3}$	$7.57109 \times 10^{-3}$	$2.195801 \times 10^{-3}$	$1.628753 \times 10^{-3}$
$\tau_p$	5.67822	1.123602	0.1407857	0.014381914	$1.272749 \times 10^{-3}$

D.C. Double Side Cooled				
Term	1	2	3	4
$r_p$	0.01177146	$6.485814 \times 10^{-3}$	$2.471007 \times 10^{-3}$	$1.607109 \times 10^{-3}$
$\tau_p$	0.9495346	0.1337950	0.01636628	$1.255571 \times 10^{-3}$

6.0 Reverse recovery ratings

(i)  $Q_{ra}$  is based on 50%  $I_{rm}$  chord as shown in Fig. 1

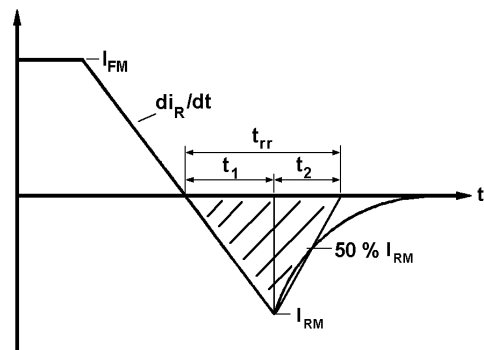


Fig. 1

(ii)  $Q_{rr}$  is based on a 150 $\mu$ s integration time i.e.

$$Q_{rr} = \int_0^{150\mu s} i_{rr} \cdot dt$$

(iii)

$$K \text{ Factor} = \frac{t_1}{t_2}$$

**Curves**

Figure 1 - Forward characteristics of Limit device

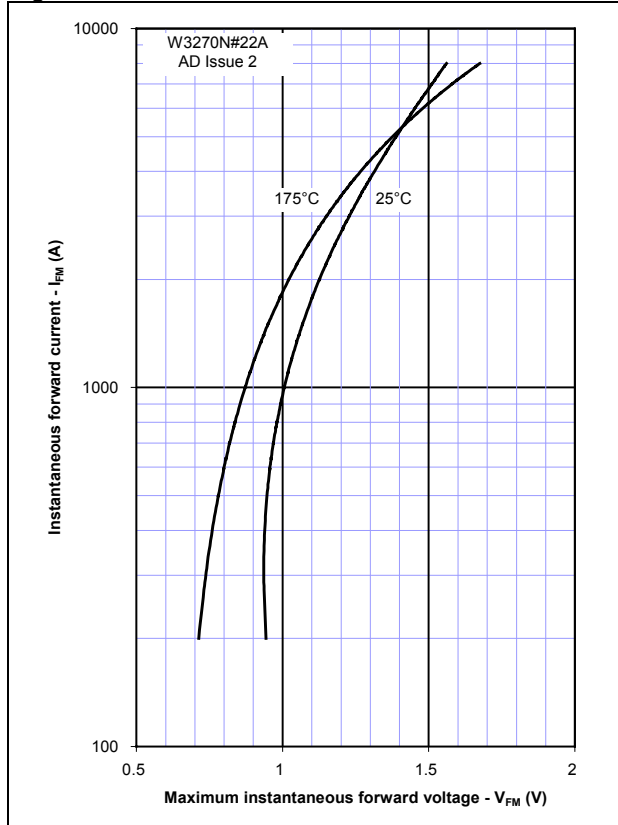


Figure 2 - Transient thermal impedance

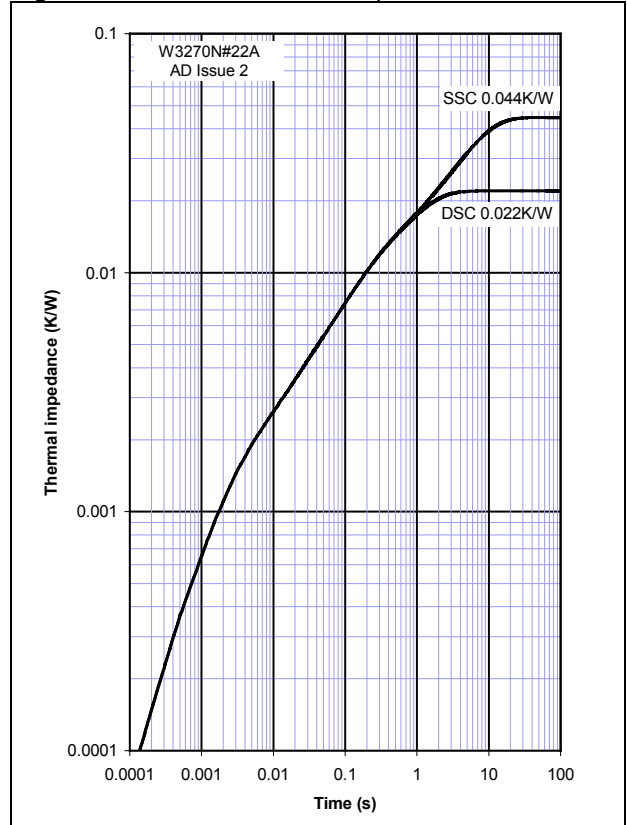


Figure 3 - Maximum surge Rating

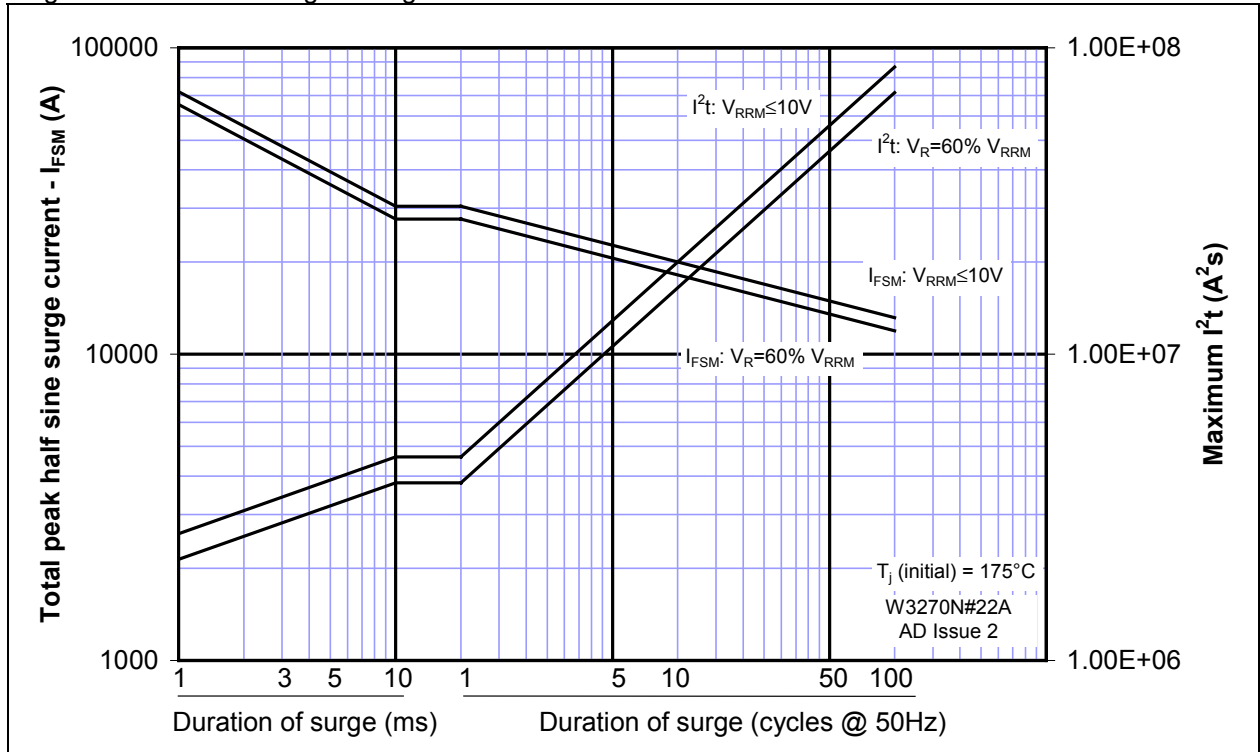


Figure 4 - Total recovered charge,  $Q_{rr}$

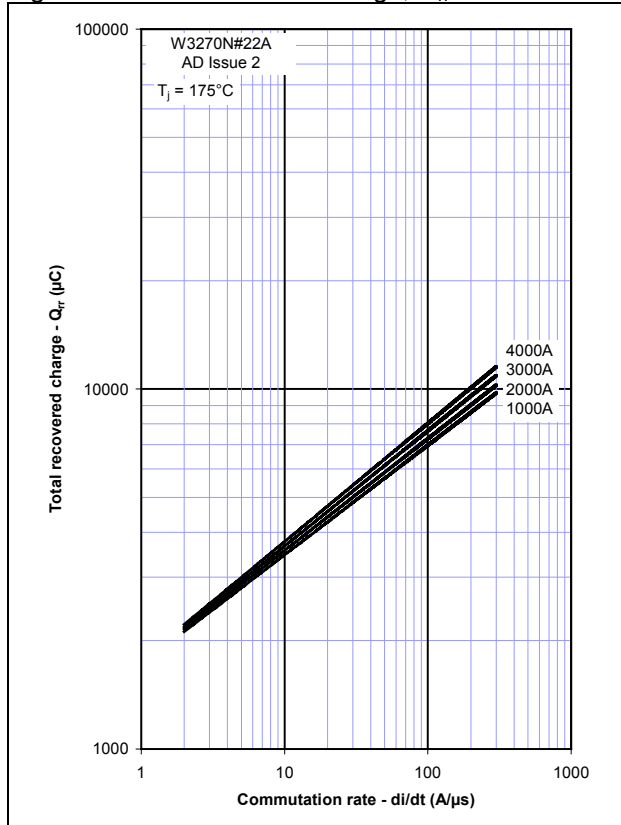


Figure 5 - Recovered charge,  $Q_{ra}$  (50% chord)

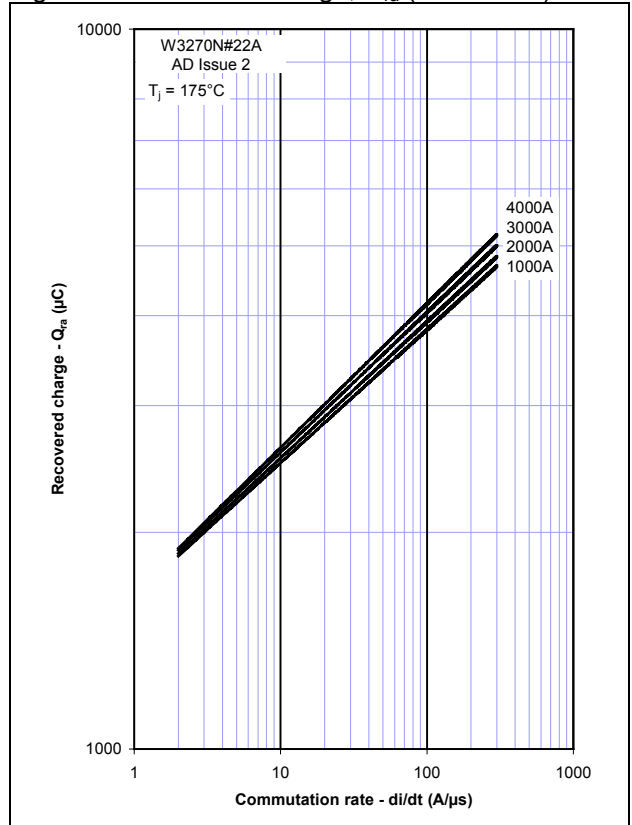


Figure 6 - Peak reverse recovery current,  $I_{rm}$

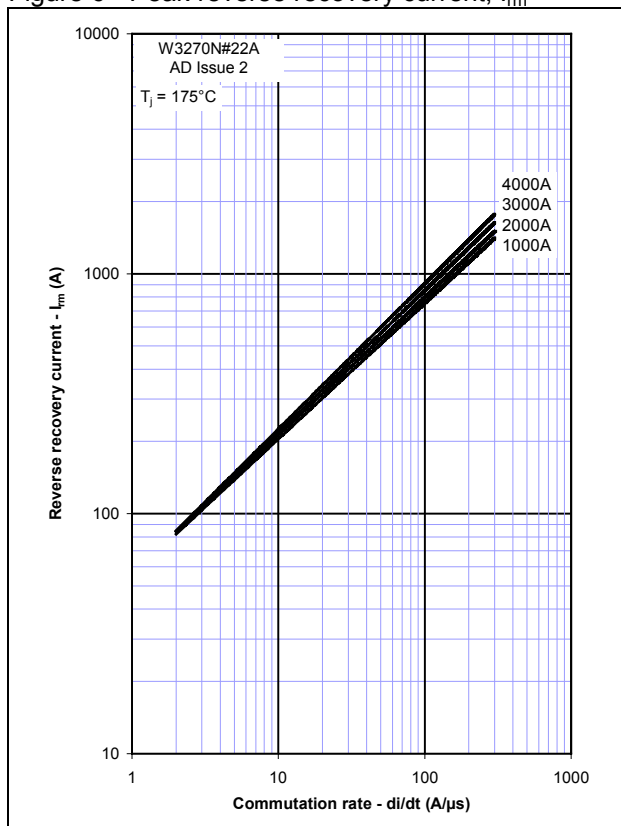


Figure 7 - Maximum recovery time,  $t_{rr}$  (50% chord)

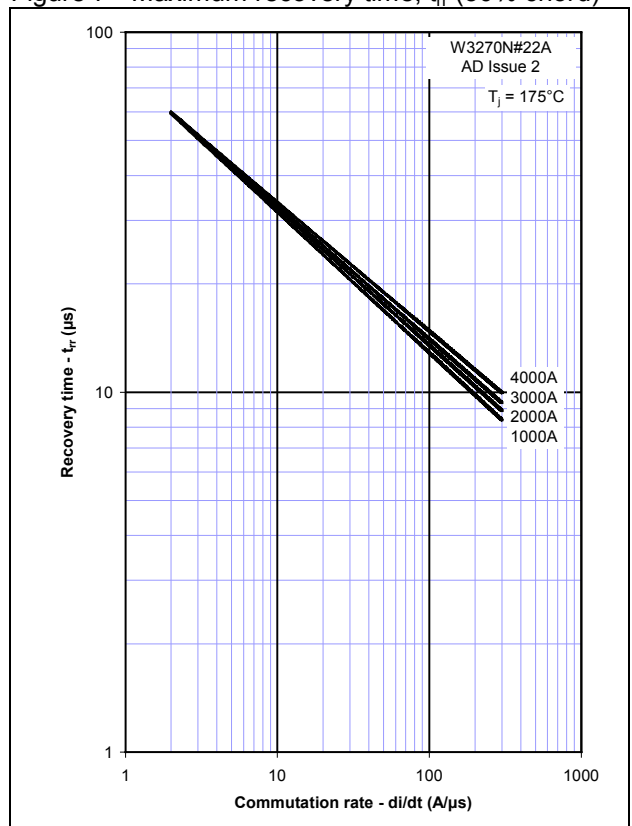


Figure 8 – Forward current vs. Power dissipation – Double Side Cooled

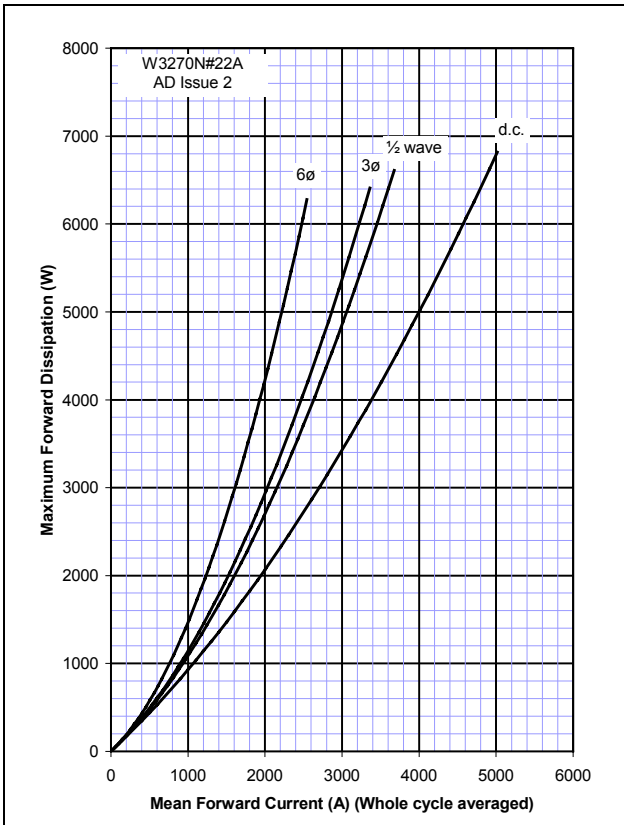


Figure 9 – Forward current vs. Heatsink temperature - Double Side Cooled

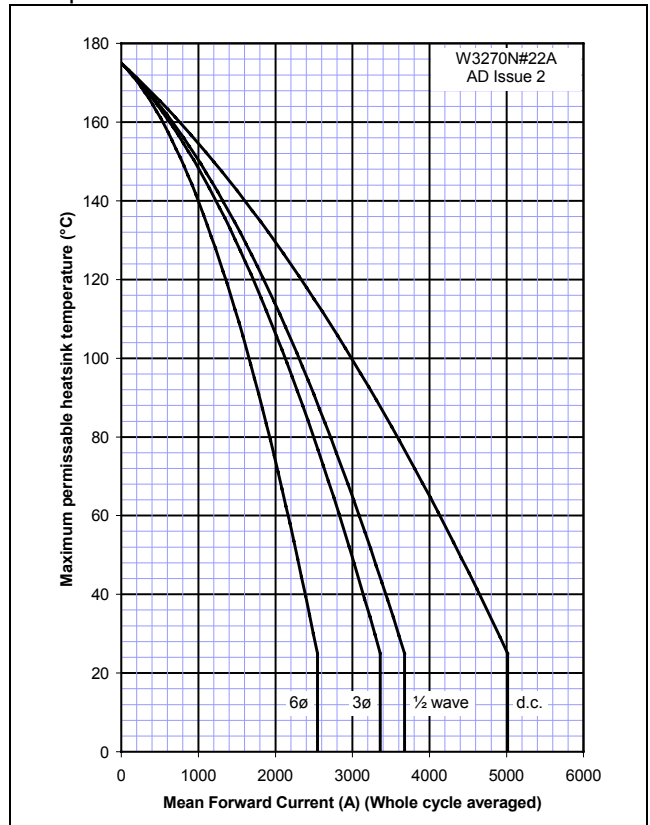


Figure 10 – Forward current vs. Power dissipation – Single Side Cooled

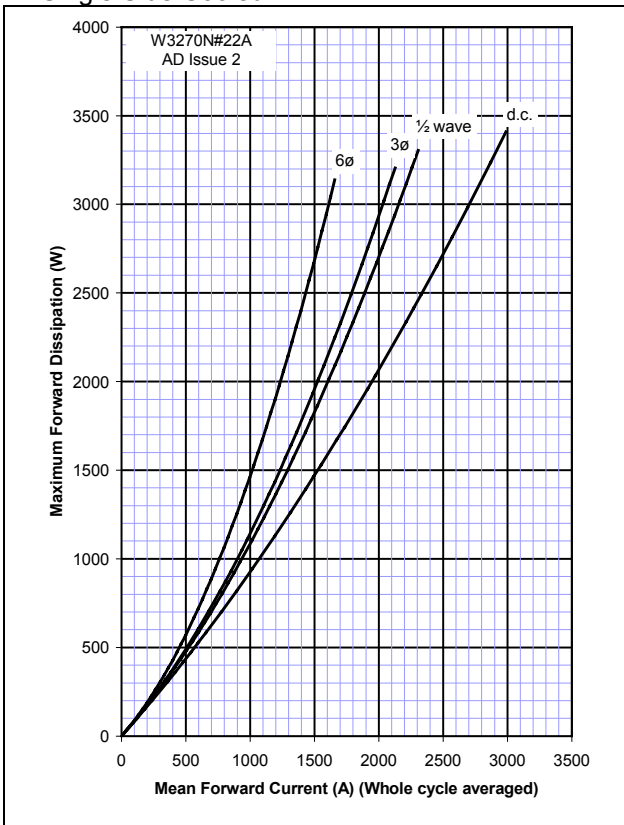
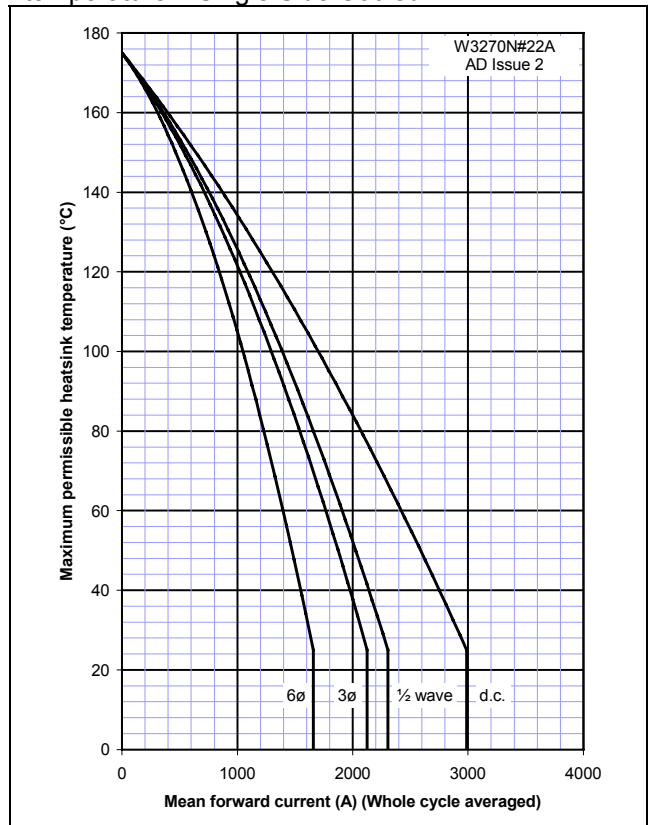
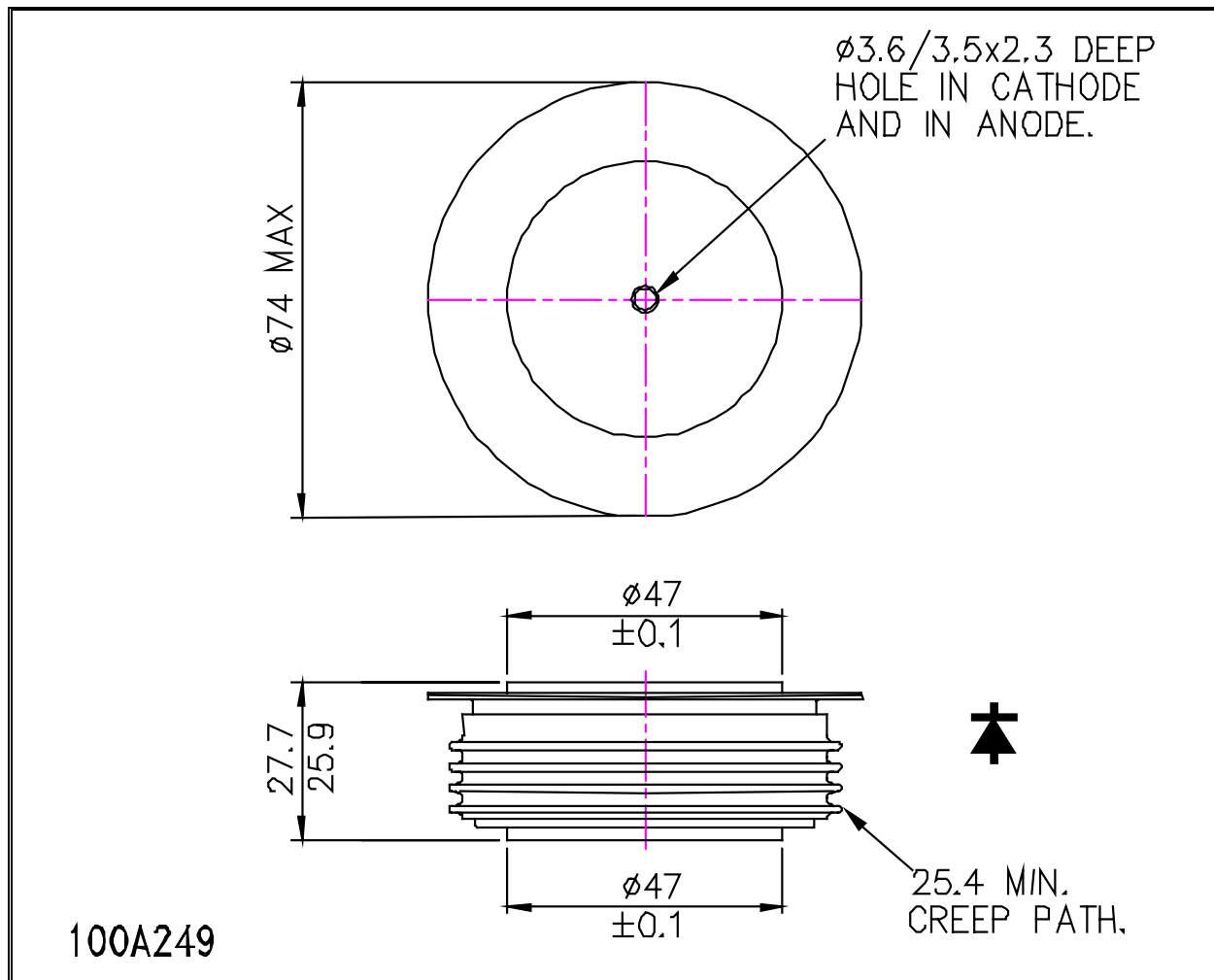


Figure 11 – Forward current vs. Heatsink temperature – Single Side Cooled





**Outline Drawing & Ordering Information**



**ORDERING INFORMATION**

(Please quote 10 digit code as below)

W3270	N#	22	A
Fixed Type Code	Outline code NC = Normal capsule NT = Rupture-rated capsule	Voltage code $V_{DRM}/100$ 22	Fixed code

Typical order code: W3270NT22A – 2200V  $V_{RRM}$ , 27.7mm clamp height, rupture rated capsule.

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